

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Makoto IMANISHI et al. :
Serial No. NEW : **Attn: APPLICATION BRANCH**
Filed January 22, 2004 : Attorney Docket No. 2004-0092

METHOD OF FORMING BUMPS ON A
WAFER UTILIZING A POST-HEATING
OPERATION, AND AN APPARATUS
THEREFORE

**(Rule 1.53(b) Divisional
of Serial No. 09/719,768,
Filed December 18, 2000)**

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEE FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975.

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

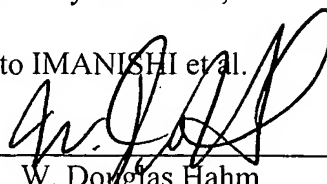
Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 10-173086, filed June 19, 1998, as acknowledged in the Declaration of this application.

A certified copy of said Japanese Patent Application is of record in parent application Serial No. 09/719,768, filed December 18, 2000.

Respectfully submitted,

Makoto IMANISHI et al.

By



W. Douglas Hahm
Registration No. 44,142
Attorney for Applicants

WDH/gtg
Washington, D.C. 20006-1021
Telephone (202) 721-8200
Facsimile (202) 721-8250
January 22, 2004